



PATENTS

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of
Mitsubishi AOKI et al.

Serial No. 09/715,000

GROUP 2811

Filed November 20, 2000

Examiner L. Thai

IMPROVED SEMICONDUCTOR WAFER
SURFACE AND METHOD OF TREATING
A SEMICONDUCTOR WAFER SURFACE

AMENDMENT

Commissioner for Patents

Washington, D.C. 20231

Sir:

Responsive to the Official Action of October 17, 2001,
please amend the above-identified application as follows:

IN THE CLAIMS:

✓
Cancel claims 34-56.

R E M A R K S

Responsive to the requirement for restriction,
Applicant elects Group I, claims 1-33 drawn to the method,
without traverse.

Non-elected claims 34-56 are cancelled herewith.

An action on the merits of the elected claims is
respectfully requested.

Respectfully submitted,

YOUNG & THOMPSON

By

Robert J. Patch
Attorney for Applicants
Registration No. 17,355
745 South 23rd Street
Arlington, VA 22202
Telephone: 703/521-2297

November 8, 2001

#4
Election
+
Amtd A
F Jones
11-15-01

RECEIVED
NOV 13 2001
TC 2800 MAIL ROOM